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Applicant: Iver E. ANDERSON, et al
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U.S. PATENT DOCUMENTS

Examiner Initial*	Document Number	Date	Name	Class	Sub Class	Filing Date
JSA	AA 4 248 905	02/1981	Harvey	427	11	01/1980
JSA	AB 4 670 217	06/1987	Henson, et al	420	562	07/1985
JSA	AC 4 695 428	09/1987	Ballentine, et al	420	561	08/1986
JSA	AD 4 758 407	07/1988	Ballentine, et al	420	560	06/1987
JSA	AE 4 778 733	10/1988	Lubrano, et al	428	647	07/1986
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	AH					
	AI					
	AJ					
	AK					

FOREIGN PATENT DOCUMENTS

Document Number	Date	Country	Class	Sub Class	Translation Yes No
AL					
AM					
AN					
AO					
AP					

OTHER DOCUMENTS (Including Author, Title, Date, Pages, Etc.)

JSA	AR	"Über den Aufbau des systems Silber-Kupfer-Zinn" Z. Metallkunde Bd. 50 (1959) H.10, p. 597
JSA	AS	"Developing Lead-Free Solders: A Challenge and Opportunity"; JOM, Vol. 45, No. 7, July 1993, pgs. 1 and 13; Sungho Jin

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